

General Description

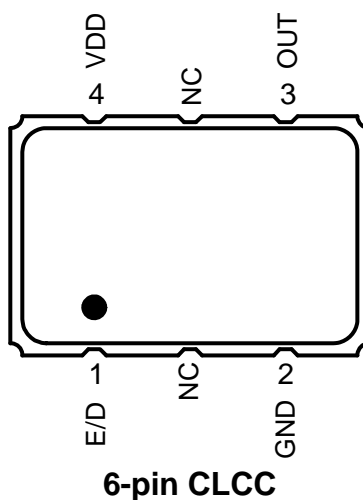
The XUH is an HCMOS Crystal Oscillator with 300fs typical phase jitter over 12kHz to 20 MHz bandwidth. Available in a wide frequency range from 0.016MHz to 167MHz, the IDT XUH Series Crystal Oscillator utilizes a family of proprietary ASICs, with a key focus on noise reduction technologies.

The 4th order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. With short lead-time, low cost, low noise, wide frequency range, excellent ambient performance, the XUH is an excellent choice over the conventional technologies. The XUH has stabilities as tight as ± 20 ppm with extremely quick delivery for both standard and custom frequencies

Features

- Frequency range: 0.016 to 167MHz
- Output Type: HCMOS
- Frequency Stability: ± 20 ppm, ± 25 ppm, ± 50 ppm, or ± 100 ppm
- Supply Voltage: 1.8V, 2.5V or 3.3V
- Phase Jitter (1.875MHz to 20MHz): 100fs typical
- Phase Jitter (12kHz to 20MHz): 300fs typical
- Package options: 5.0mm x 3.2mm x 1.2mm (JS4)
7.0mm x 5.0mm x 1.3mm (JU4)
- Operating Temperatures: -20°C to +70°C or -40°C to +85°C

Pin Assignment



Pin Descriptions

Pin Number	Pin Name	Description
1	E/D	Enable/Disable ¹ (0=Output Disabled)
2	GND	Connect to ground
3	OUT	Output
4	VDD	Supply voltage

1. Pulled high internally.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the XUH. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
VDD	-0.5 to +5.0 V
E/D	-0.5 V to VDD + 0.5 V
OUT	-0.5 V to VDD + 0.5 V
Storage Temperature	-55°C to 125°C
Theta Ja (Junction to Ambient)	102°C/W – Still Air

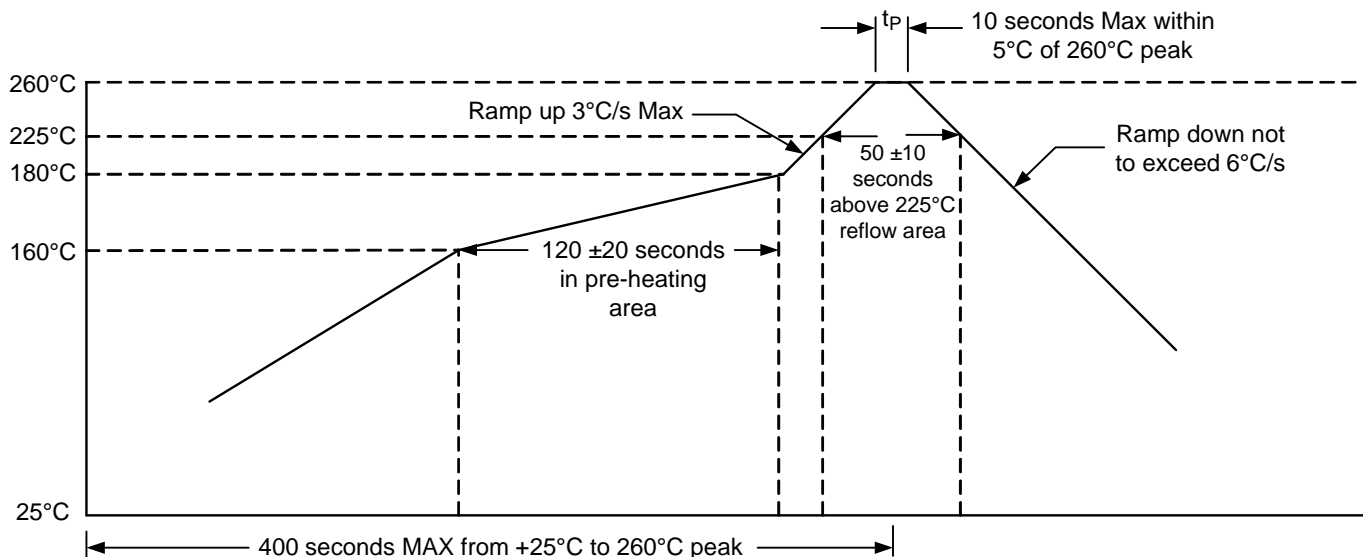
ESD Compliance

Human Body Model (HBM)	1000V
Machine Model (MM)	150V

Mechanical Testing

Parameter	Test Method
Mechanical Shock	Half-Sine wave with 0.3ms 3000G X, Y, Z each direction 1 time
Mechanical Vibration	Frequency: 10 to 55 MHz Amplitude: 1.5mm Frequency: 55~2000Hz Peak value: 20G Duration time: 4H for each X, Y, Z axis Total 12hours
High Temperature Burn-in	2000 Hours 125°C (under power)
Hermetic Seal	Gross leak (Air leak test) Fine leak (Helium leak test) He-pressure: 6kgf/cm ² 2 hours.

Solder Reflow Profile



DC Characteristics

($V_{DD} = 3.3\text{ V} \pm 5\%$, $T_A = -20^\circ\text{C}$ to $+70^\circ\text{C}$; -40° to $+85^\circ\text{C}$) Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	I_{DD}	Standard Frequencies		90		mA
Output HIGH Voltage	V_{OH}	$C_L = 15\text{pF}$	$90\%V_{DD}$			V
Output LOW Voltage	V_{OL}	$C_L = 15\text{pF}$			$10\%V_{DD}$	V
Enable/Disable Input HIGH Voltage (Output enabled)*	V_{IH}		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	V_{IL}				$30\%V_{DD}$	V

* A pullup resistor from pin 4 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

($V_{DD} = 3.3\text{ V} \pm 5\%$, $T_A = -20^\circ\text{C}$ to $+70^\circ\text{C}$; -40° to $+85^\circ\text{C}$) Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	F_{OUTR}		0.016		167	MHz
Frequency Stability		Temperature = -20°C to $+70^\circ\text{C}$	± 20		± 100	ppm
		Temperature = -40°C to $+85^\circ\text{C}$	± 25		± 100	ppm
Aging (1 st year)		$T_a = 25^\circ\text{C}$			± 3	
Aging (10 years)		$T_a = 25^\circ\text{C}$			± 10	
Output Load					15	pF
Start-up Time	T_{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		10% to 90% V_{DD} , Standard Frequencies			3	ns
Output Fall Time		90% to 10% V_{DD} , Standard Frequencies			3	ns
Output Clock Duty Cycle	T_{DTCY}	@ 50% V_{DD} Std. Frequencies to 125MHz Std. Frequencies >125MHz	45 40		55 60	%
Output Enable/ Disable Time	T_{OE}				100	ns
Period Jitter, RMS	J_{PER}	Frequency = 156.25MHz		5		psec
Random Jitter	R_J	Frequency = 156.25MHz		0.6		psec
Deterministic Jitter	D_J	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		10		psec
Total Jitter	T_J			19		psec
Phase Jitter (12kHz – 20MHz)	ϕ_{JITTER}	Standard Frequencies		300	400	fsec
Phase Noise Performance Frequency = 156.25MHz	ϕ_{NOISE}	100Hz of Carrier		-97		dBc/Hz
		1kHz of Carrier		-116		dBc/Hz
		10kHz of Carrier		-126		dBc/Hz
		100kHz of Carrier		-133		dBc/Hz
		1MHz of Carrier		-147		dBc/Hz
		10MHz of Carrier		-156		dBc/Hz
Output Frequency (Standards)	F_{OUT}	10MHz, 12MHz, 12.288MHz, 16MHz, 20MHz, 24MHz, 24.576MHz, 25MHz, 33.333MHz, 40MHz, 48MHz, 50MHz, 100MHz, 125MHz, 156.25MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices

DC Characteristics

($V_{DD} = 2.5\text{ V} \pm 5\%$, $T_A = -20^\circ\text{C}$ to $+70^\circ\text{C}$; -40°C to $+85^\circ\text{C}$) Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	I_{DD}	Standard Frequencies		80		mA
Output HIGH Voltage	V_{OH}	$C_L = 10\text{pF}$	$90\%V_{DD}$			V
Output LOW Voltage	V_{OL}	$C_L = 10\text{pF}$			$10\%V_{DD}$	V
Enable/Disable Input HIGH Voltage (Output enabled)*	V_{IH}		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	V_{IL}				$30\%V_{DD}$	V

* A pullup resistor from pin 4 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

($V_{DD} = 2.5\text{ V} \pm 5\%$, $T_A = -20^\circ\text{C}$ to $+70^\circ\text{C}$; -40°C to $+85^\circ\text{C}$) Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	F_{OUTR}		0.016		167	MHz
Frequency Stability		Temperature = -20°C to $+70^\circ\text{C}$	± 20		± 100	ppm
		Temperature = -40°C to $+85^\circ\text{C}$	± 25		± 100	ppm
Output Load					10	pF
Start-up Time	T_{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		10% to 90% V_{DD} , Standard Frequencies			3	ns
Output Fall Time		90% to 10% V_{DD} , Standard Frequencies			3	ns
Output Clock Duty Cycle	T_{DTCY}	@ 50% V_{DD} Std. Frequencies to 62.5MHz Std. Frequencies >62.5MHz	45 40		55 60	%
Output Enable/ Disable Time	T_{OE}				100	ns
Period Jitter, RMS	J_{PER}	Frequency = 125MHz		7		psec
Random Jitter	R_J	Frequency = 125MHz		0.7		psec
Deterministic Jitter	D_J	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		10		psec
Total Jitter	T_J			20		psec
Phase Jitter (12kHz – 20MHz)	ϕ_{JITTER}	Frequency = 125MHz		350	500	fsec
Phase Noise Performance Frequency = 125 MHz	ϕ_{NOISE}	100Hz of Carrier		-94		dBc/Hz
		1kHz of Carrier		-116		dBc/Hz
		10kHz of Carrier		-123		dBc/Hz
		100kHz of Carrier		-129		dBc/Hz
		1MHz of Carrier		-150		dBc/Hz
		10MHz of Carrier		-156		dBc/Hz
Output Frequency (Standards)	F_{OUT}	10MHz, 12MHz, 12.288MHz, 16MHz, 20MHz, 24MHz, 24.576MHz, 25MHz, 33.333MHz, 40MHz, 48MHz, 50MHz, 100MHz, 125MHz, 156.25MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C . We do not recommend hand soldering the devices

DC Characteristics

($V_{DD} = 1.8\text{ V} \pm 5\%$, $T_A = -20^\circ\text{C}$ to $+70^\circ\text{C}$; -40° to $+85^\circ\text{C}$) Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	I_{DD}	Standard Frequencies		54		mA
Output HIGH Voltage	V_{OH}	$C_L = 10\text{pF}$	$90\%V_{DD}$			V
Output LOW Voltage	V_{OL}	$C_L = 10\text{pF}$			$10\%V_{DD}$	V
Enable/Disable Input HIGH Voltage (Output enabled)*	V_{IH}		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	V_{IL}				$30\%V_{DD}$	V

* A pullup resistor from pin 4 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

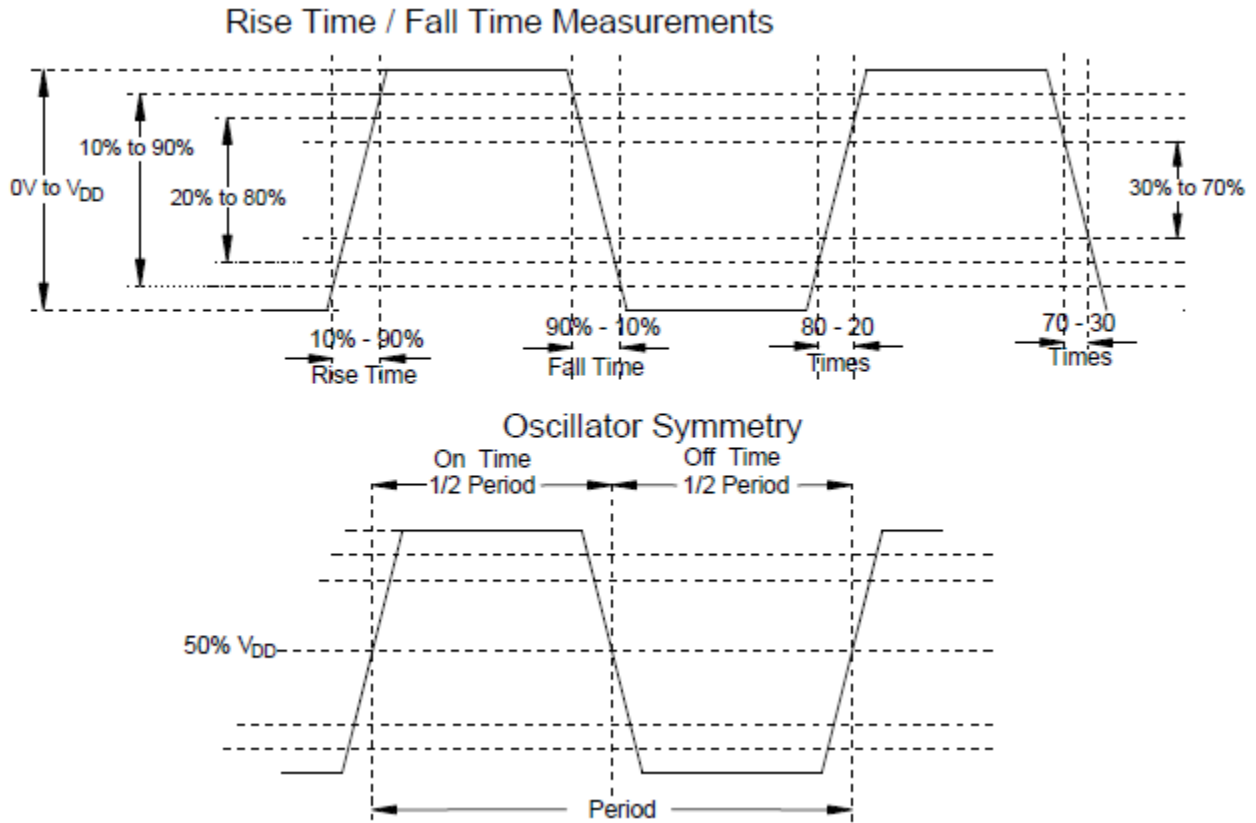
AC Characteristics

($V_{DD} = 1.8\text{ V} \pm 5\%$, $T_A = -20^\circ\text{C}$ to $+70^\circ\text{C}$; -40° to $+85^\circ\text{C}$) Below are guaranteed for listed standard frequencies.

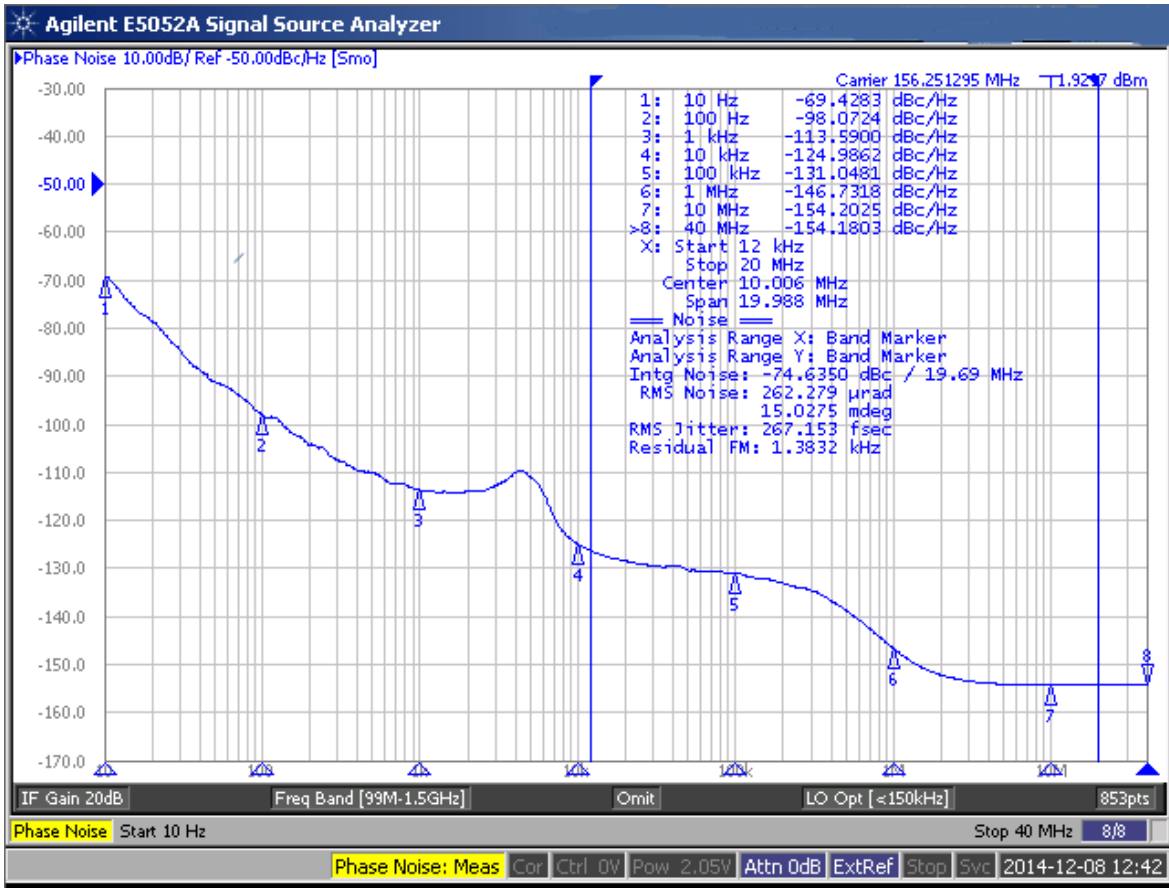
Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	F_{OUTR}		0.016		62.5	MHz
Frequency Stability		Temperature = -20°C to $+70^\circ\text{C}$	± 20		± 100	ppm
		Temperature = -40°C to $+85^\circ\text{C}$	± 25		± 100	ppm
Output Load					10	pF
Start-up Time	T_{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		10% to 90% V_{DD} , Standard Frequencies		5		ns
Output Fall Time		90% to 10% V_{DD} , Standard Frequencies		5		ns
Output Clock Duty Cycle	T_{DTCY}	@ 50% V_{DD}	40		60	%
Output Enable/ Disable Time	T_{OE}				100	ns
Period Jitter, RMS	J_{PER}	Frequency = 62.5MHz		7		psec
Random Jitter	R_J	Frequency = 62.5MHz		0.9		psec
Deterministic Jitter	D_J	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		10		psec
Total Jitter	T_J			20		psec
Phase Jitter (12kHz – 20MHz)	ϕ_{JITTER}	Frequency = 62.5MHz		800	1200	fsec
Phase Noise Performance Frequency = 62.5MHz	ϕ_{NOISE}	100Hz of Carrier		-94		dBc/Hz
		1kHz of Carrier		-113		dBc/Hz
		10kHz of Carrier		-123		dBc/Hz
		100kHz of Carrier		-128		dBc/Hz
		1MHz of Carrier		-152		dBc/Hz
		10MHz of Carrier		-155		dBc/Hz
Output Frequency (Standards)	F_{OUT}	10MHz, 12MHz, 12.288MHz, 16MHz, 20MHz, 24MHz, 24.576MHz, 25MHz, 33.333MHz, 40MHz, 48MHz, 50MHz, 62.5MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C . We do not recommend hand soldering the devices

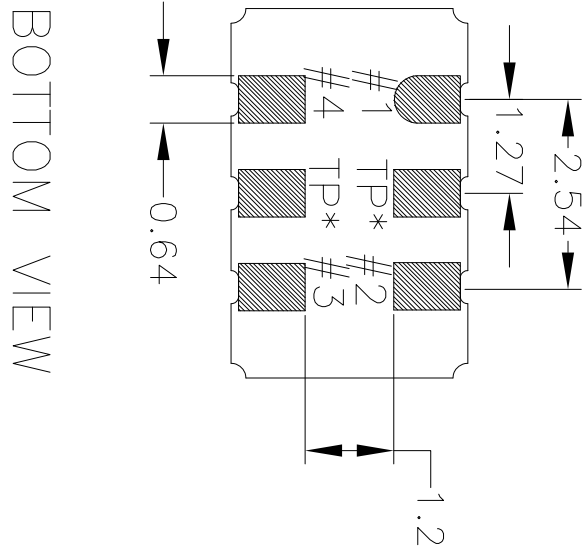
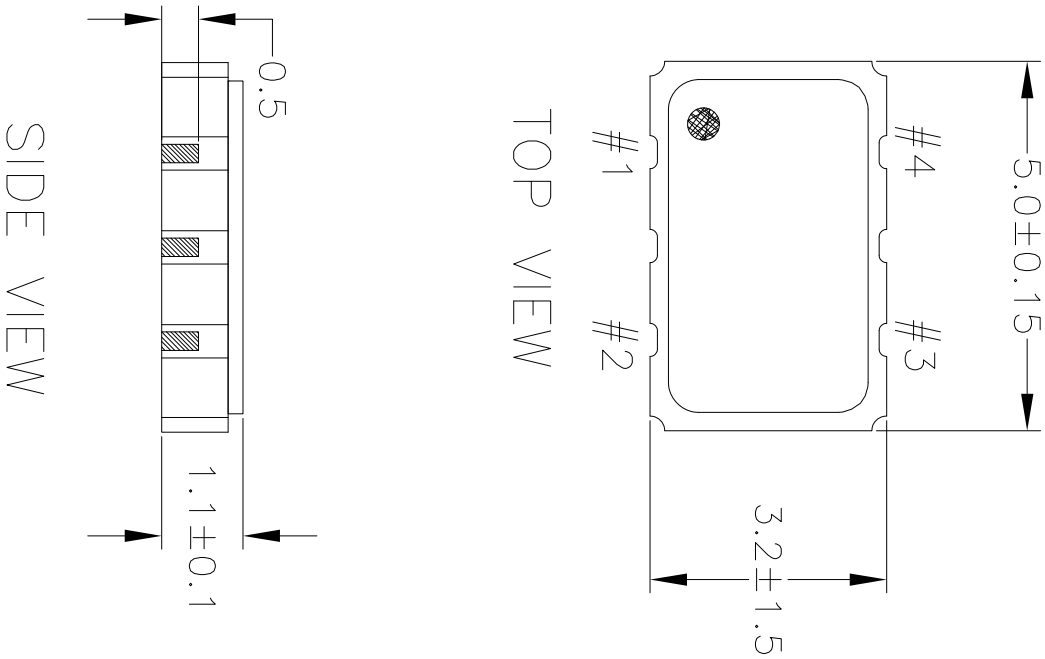
Output Waveform



Typical Phase Noise (3.3V)



JS4 Package Outline and Dimensions



NOTES:
1. ALL DIMENSIONS IN MM.

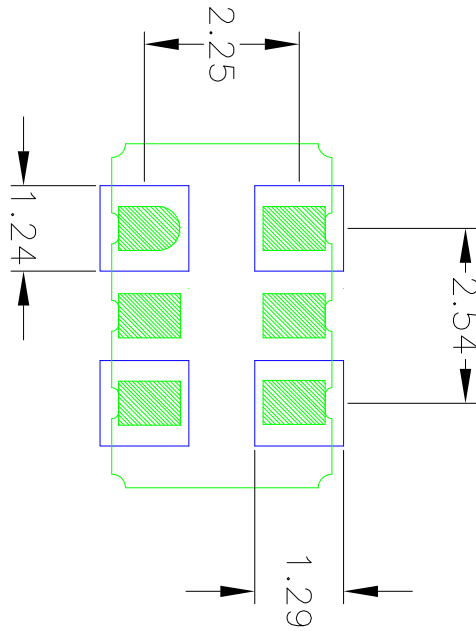
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	08/21/12	K. Stohn
01	UPDATED LID TOLERANCES	12/03/12	K. Stohn
02	UPDATE PACKAGE DRAWING	8/8/14	JHUA

TOLERANCES UNLESS SPECIFIED	
DECIMAL	±
ANGULAR	±
XXX±	
XXXX±	
XXXX±	
APPROVALS	DATE
DRAWN <i>gjs</i>	07/16/12
CHECKED	
SIZE	DRAWING No.
C	PSC-4429
REV	02

6024 Silver Creek Valley Rd
San Jose, CA 95138
PHONE: (408) 727-6116
FAX: (408) 492-8674

WWW.IDT.COM
TITLE JS4 PACKAGE OUTLINE
5.0 x 3.2 mm BODY
1.1 mm Thick
PSC-4429
NO NOT SCALE DRAWING SHEET 1 OF 2

JS4 Package Outline and Dimensions (cont.)



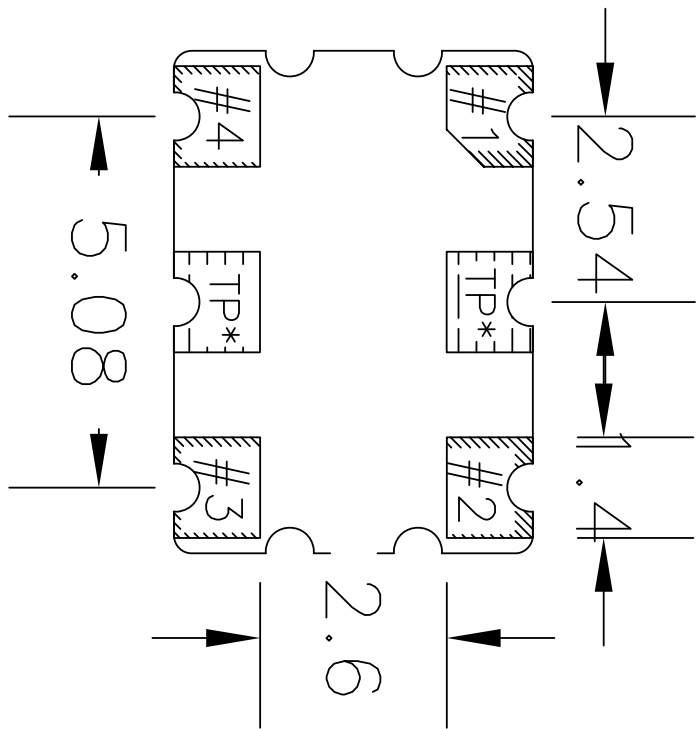
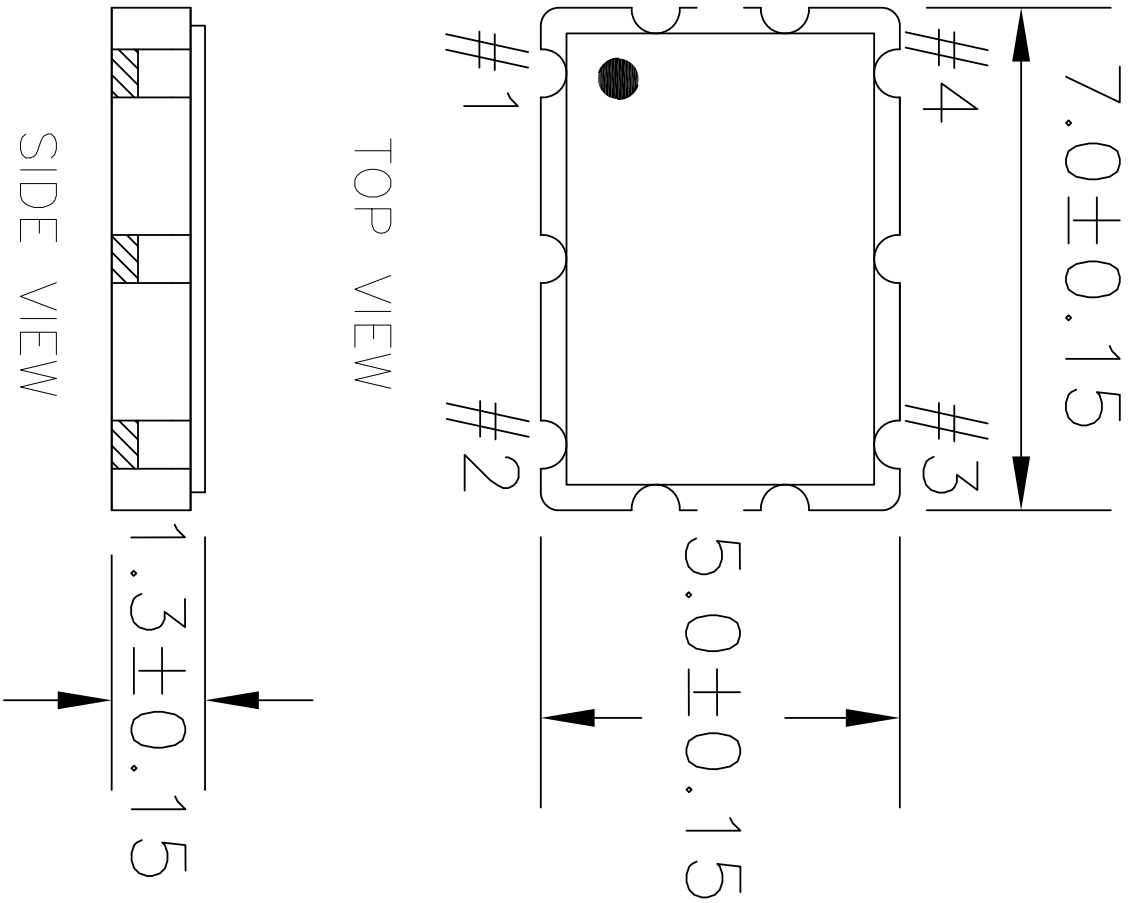
RECOMMENDED LAND PATTERN

- NOTES:
1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
 2. TOP DOWN VIEW, AS VIEWED ON PCB.
 3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
 4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
 5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	08/21/12	K. Sidhn
01	UPDATED LID TOLERANCES	12/03/12	K. Sidhn
02	UPDATE PACKAGE DRAWING	8/8/14	JHUA

TOLERANCES UNLESS SPECIFIED		www.IDT.COM	
DECIMAL	ANGULAR	6024 Silver Creek Valley Rd San Jose, CA 95138 Phone: (408) 727-6116 Fax: (408) 482-8874	
XXXX	±	IDT™	
XXXXX		TITLE JS4 PACKAGE OUTLINE	
APPROVALS	DATE	5.0 x 3.2 mm BODY	
DRAWN	07/18/12	1.1 mm Thick	
CHECKED		SIZE C	
		DRAWING No. PSC-4429	
		DO NOT SCALE DRAWING	
		REV 02	
		SHEET 2 OF 2	

JU4 Package Outline and Dimensions

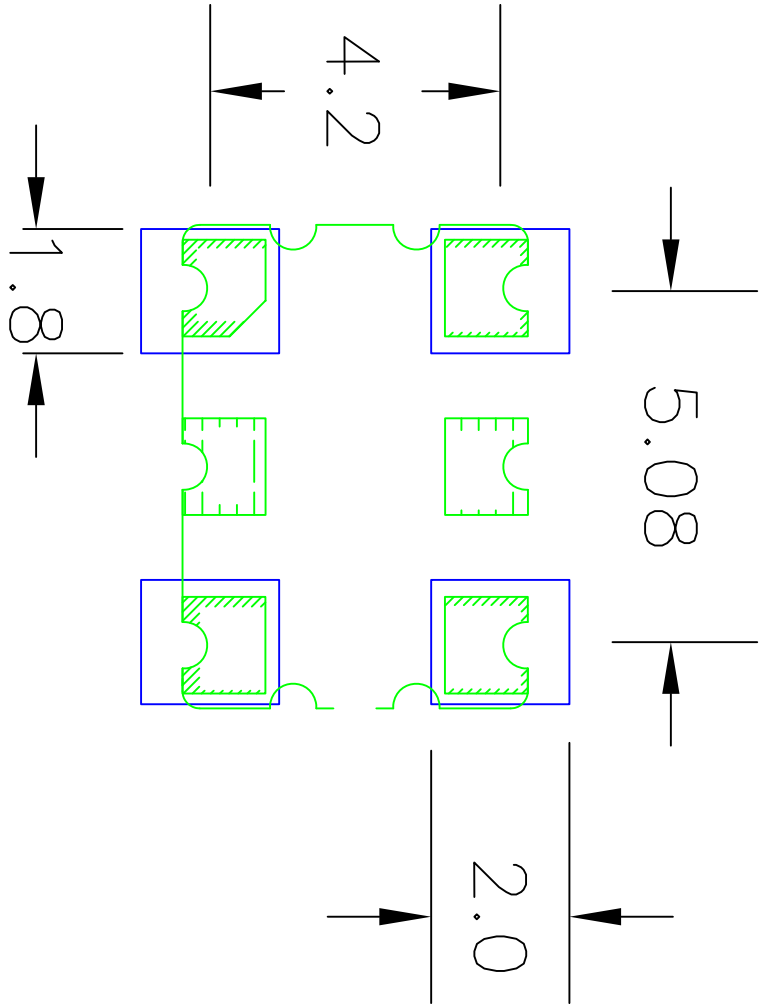


NOTES:
1. ALL DIMENSIONS IN MM.

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	10/09/12	KS
01	UPDATE PACKAGE DRAWING	8/11/14	JHUUA

TOLERANCES UNLESS SPECIFIED			6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674
DECIMAL	ANGULAR		
XXX±	±	www.IDT.com	
XXXX±			
APPROVALS	DATE	TITLE	SIZE
DRAWN XZ	10/09/12	JU4 PACKAGE OUTLINE	C
CHECKED		7.0 x 5.0 mm BODY	DRAWING No.
		1.3 mm Thick	PSC-4431
			REV
			01
DO NOT SCALE DRAWING			SHEET 1 OF

JU4 Package Outline and Dimensions (cont.)



RECOMMENDED LAND PATTERN

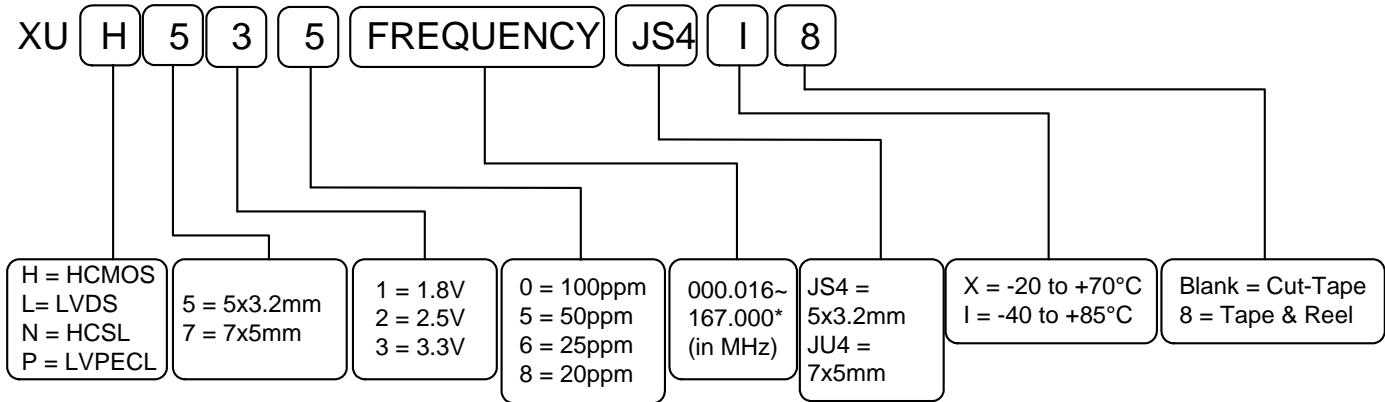
NOTES:

1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

REVISIONS			
REV	DESCRIPTION	DATE	APPROVER
00	INITIAL RELEASE	10/09/12	KS
01	UPDATE PACKAGE DRAWING	8/11/14	JHU4

TOLERANCES UNLESS SPECIFIED			
DECIMAL	ANGULAR	6024 Silver Creek Valley R San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674	
±	±	www.IDT.com	
APPROVALS	DATE	TITLE	
XXXXX	10/09/12	JU4 PACKAGE OUTLINE	
XXXXX		DRAWN BY	
XXXXX		7.0 x 5.0 mm BODY	
CHECKED		1.3 mm Thick	
SIZE	DRAWING No.	REN	
C	PSC-4431	0	
DO NOT SCALE DRAWING			
			SHEET 2 OF

Ordering Information



* See table or contact IDT for custom frequencies

Revision History

Rev.	Date	Originator	Description of Change
A	01/08/15	B. Chandhoke	Initial release.



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